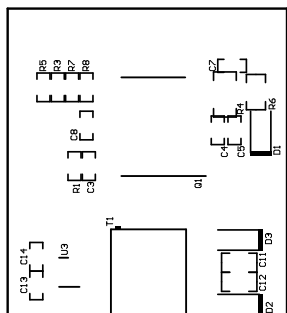
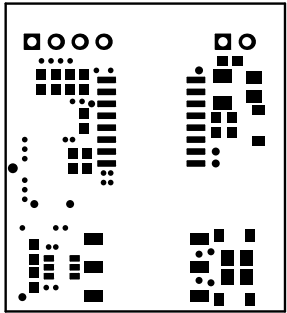


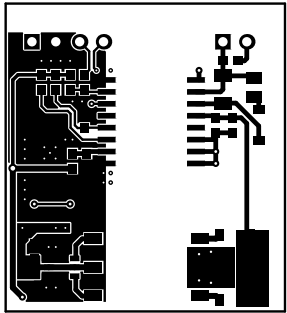
For evaluation only; not FCC approved for resale.



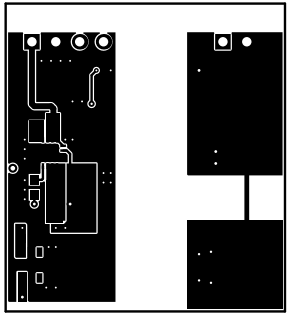
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00638		
PLOT NAME = Top Overlay	GENERATED : 6/29/2017 10:00:37 AM	TEXAS INSTRUMENTS	



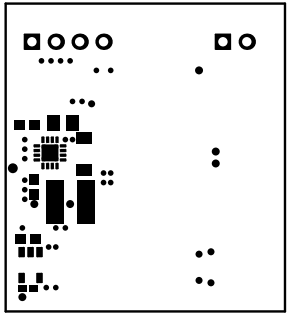
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00638		
PLOT NAME = Top Solder Mask	GENERATED : 6/29/2017 10:00:38 AM	TEXAS INSTRUMENTS	



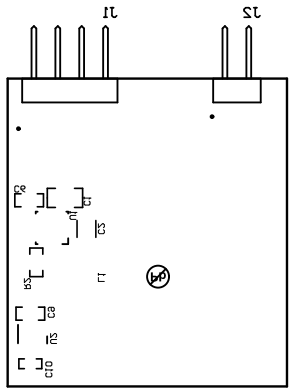
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00638		
PLOT NAME = Top Layer	GENERATED : 6/29/2017 10:00:39 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00638		
PLOT NAME = Bottom Layer	GENERATED : 6/29/2017 10:00:40 AM	TEXAS INSTRUMENTS	

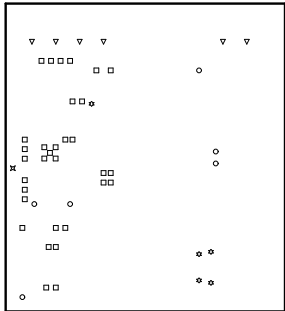


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SVN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00638		
PLOT NAME = Bottom Solder Mask	GENERATED : 6/29/2017 10:00:41 AM	TEXAS INSTRUMENTS	

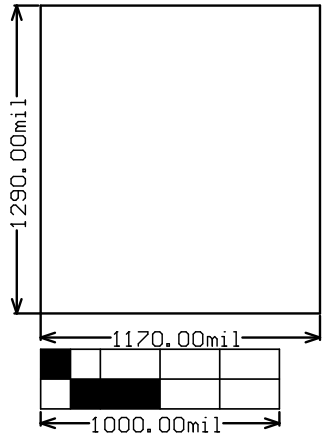


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00638		
PLOT NAME = Bottom Overlay	GENERATED : 6/29/2017 10:00:42 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
□	32	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
☆	5	9.84mil (0.250mm)	PTH	Round	Top Layer - Bottom Layer	
○	6	11.81mil (0.300mm)	PTH	Round	Top Layer - Bottom Layer	
⊗	1	19.69mil (0.500mm)	PTH	Round	Top Layer - Bottom Layer	
▽	6	39.37mil (1.000mm)	PTH	Round	Top Layer - Bottom Layer	
	50 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00638		
PLOT NAME = Drill Drawing	GENERATED : 6/29/2017	10:00:43 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00638	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00638		
PLOT NAME = Board Dimensions	GENERATED : 6/29/2017 10:00:44 AM	TEXAS INSTRUMENTS	



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